## LNJ912W8BRA

### Surface Mounting Chip LED

TSS Type

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

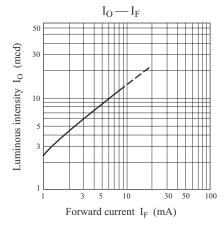
Parameter	Symbol	Rating	Unit	
Power dissipation	$P_{D}$	40	mW	
Forward current	$I_{\mathrm{F}}$	10	mA	
Pulse forward current	$I_{FP}$	I <sub>FP</sub> 50		
Reverse voltage	V <sub>R</sub>	5	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

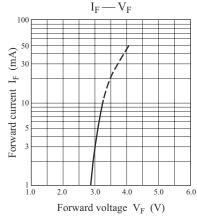
#### ■ Lighting Color

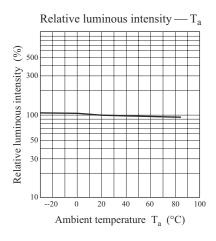
• Blue

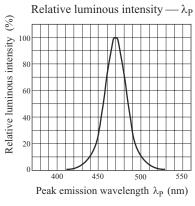
### ■ Electro-Optical Characteristics $T_a = 25$ °C

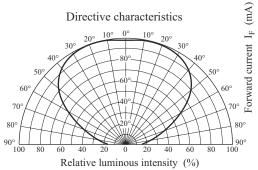
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I <sub>O</sub>	$I_F = 5 \text{ mA}$	3.2	8.5		mcd
Reverse current	$I_R$	$V_R = 5 V$			10	μΑ
Forward voltage	V <sub>F</sub>	$I_F = 5 \text{ mA}$		3.2	3.7	V
Peak emission wavelength	$\lambda_{\mathrm{P}}$	$I_F = 5 \text{ mA}$		470		nm
Spectral half band width	Δλ	$I_F = 5 \text{ mA}$		30		nm

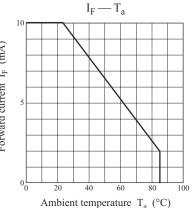








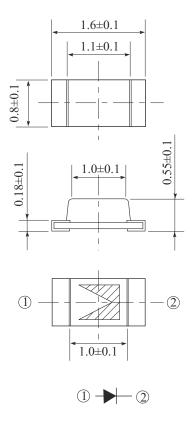




LNJ912W8BRA Panasonic

■ Package (Unit: mm)

## KLTFTN2K1200



- Pin name
  - 1: Anode
  - 2: Cathode

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